

PMEG100T50ELP

100 V, 5 A low leakage current Trench Schottky barrier rectifier

19 July 2024

Product data sheet

1. General description

Trench Schottky barrier rectifier encapsulated ina CFP5 (SOD128) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package

3. Applications

- · High efficiency DC-to-DC conversion
- LED lighting
- · Switch mode power supply
- · Freewheeling applications
- · Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 148 °C		-	-	5	Α
V _R	reverse voltage	T _j = 25 °C		-	-	100	V
V _F	forward voltage	I _F = 5 A; pulsed; T _j = 25 °C	[1]	-	815	895	mV
I _R	reverse current	V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.25	1.75	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.42	2.2	mA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		K _[K] A
2	А	anode	1 2 2 CFP5 (SOD128)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	number Package					
	Name	Description	Version			
PMEG100T50ELP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128			

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG100T50ELP	E6

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	δ = 1; $T_{sp} \le 140 ^{\circ}\text{C}$		-	7.1	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 148 °C		-	5	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	90	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.75	W
			[2]	-	1.2	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

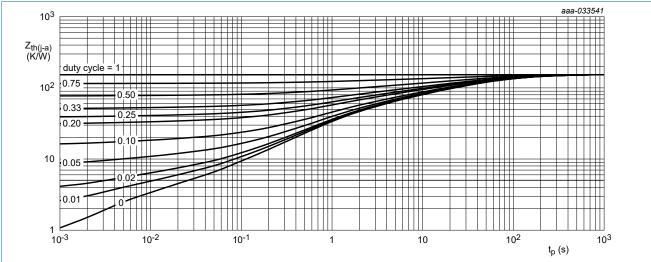
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

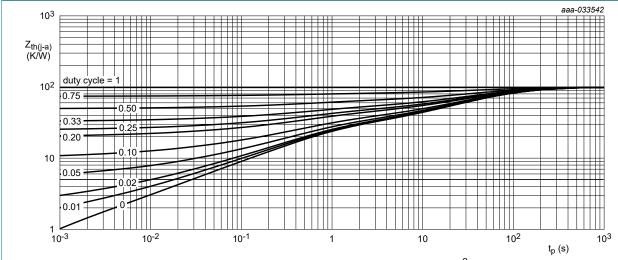
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, single-sided copper, tin-plated and standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, tin-plated and mounting pad for cathode 1 cm²

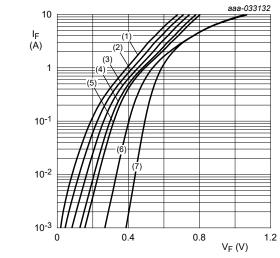
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 1 \text{ mA}$; pulsed; $T_j = 25 \text{ °C}$	[1]	100	-	-	V
V_{F}	forward voltage	I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	540	610	mV
		I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	630	710	mV
		I _F = 3 A; pulsed; T _j = 25 °C	[1]	-	705	800	mV
		I _F = 5 A; pulsed; T _j = 25 °C	[1]	-	815	895	mV
		I _F = 5 A; pulsed; T _j = -40 °C	[1]	-	820	895	mV
		I _F = 5 A; pulsed; T _j = 125 °C	[1]	-	660	750	mV
		I _F = 5 A; pulsed; T _j = 150 °C		-	620	690	mV
I_R	reverse current	V _R = 60 V; pulsed; T _j = 25 °C	[1]	-	0.1	0.8	μA
		V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.25	1.75	μΑ
		$V_R = 100 \text{ V}$; pulsed; $T_j = 125 \text{ °C}$	[1]	-	0.42	2.2	mA
		V _R = 100 V; pulsed; T _j = 150 °C	[1]	-	1.65	8	mA
C _d	diode capacitance	$V_R = 1 \text{ V; } f = 1 \text{ MHz; } T_j = 25 ^{\circ}\text{C}$		-	300	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	85	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	9	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	12.5	-	ns
I _{RM}	peak reverse recovery current			-	1.3	-	А
Q _{rr}	reverse recovery charge			-	10	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	480	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

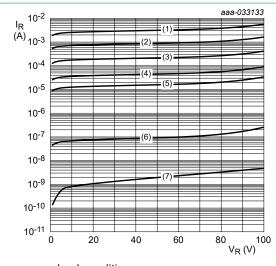
(3) Tj = 125 °C

(4) Tj = 100 °C

(5) Tj = 85 °C (6) Tj = 25 °C

 $(7) \text{ Tj} = -40 ^{\circ}\text{C}$

Fig. 3. Forward current as a function of forward voltage; typical values



pulsed condition

 $(1) T_i = 175 °C$

(2) T_{i} = 150 °C

 $(3) T_j = 125 °C$

 $(4) T_i = 100 °C$

(5) $T_j = 85 ^{\circ}C$ (6) $T_i = 25 ^{\circ}C$

 $(7) T_i = -40 ^{\circ}C$

Fig. 4. Reverse current as a function of reverse voltage; typical values

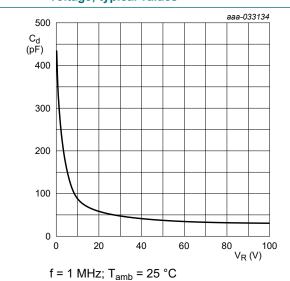
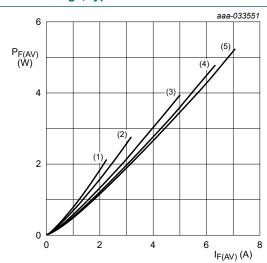


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T_j = 100 °C

 $(1) \delta = 0.1$

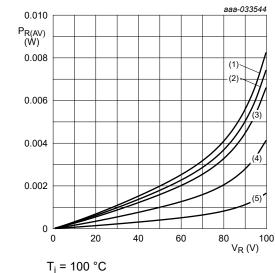
 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 0.8$

 $(5) \delta = 1; DC$

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



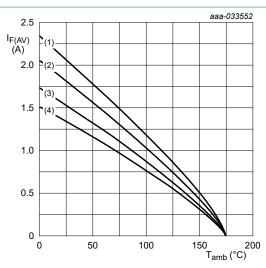
 $(1) \delta = 1; DC$

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$ $(5) \delta = 0.2$

Average reverse power dissipation as a Fig. 7. function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

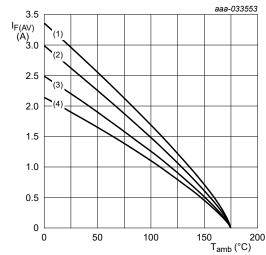
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Average forward current as a function of Fig. 8. ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

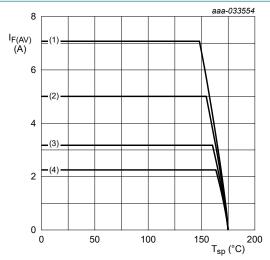
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Average forward current as a function of Fig. 9. ambient temperature; typical values



Tj = 175 °C

(1) δ = 1; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

aaa-033549

100 V, 5 A low leakage current Trench Schottky barrier rectifier

50

100

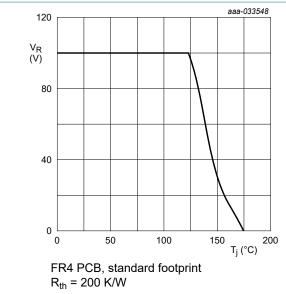
FR4 PCB, mounting pad for cathode 1 cm²

120

80

40

V_R (V)



R_{th} = 200 K/W R_{th} = 120 K/W

Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values

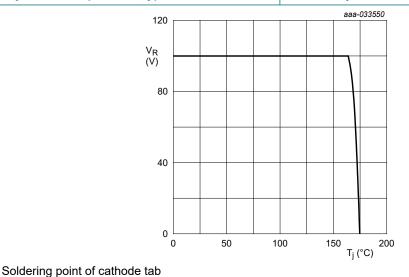


Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

 $R_{th} = 12 \text{ K/W}$

11. Test information

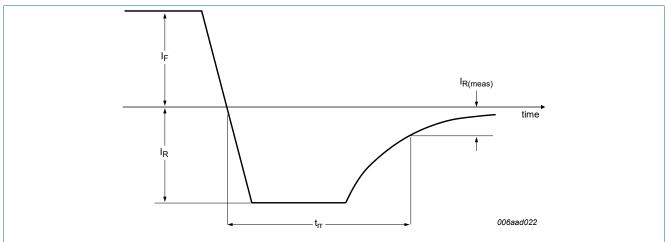


Fig. 14. Reverse recovery definition; step recovery

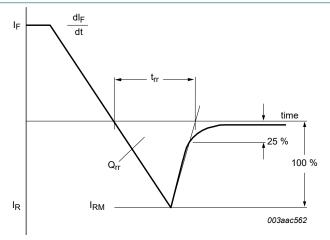


Fig. 15. Reverse recovery definition; ramp recovery

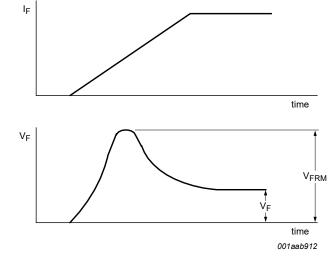
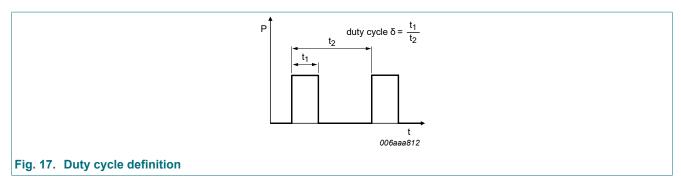


Fig. 16. Forward recovery definition

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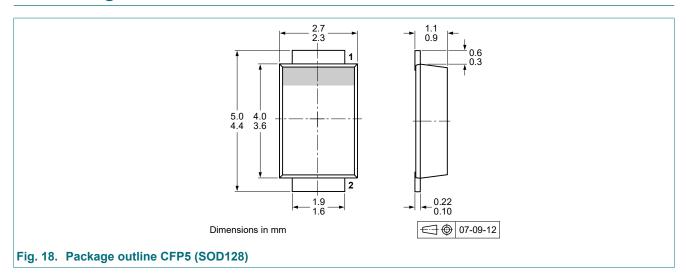
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

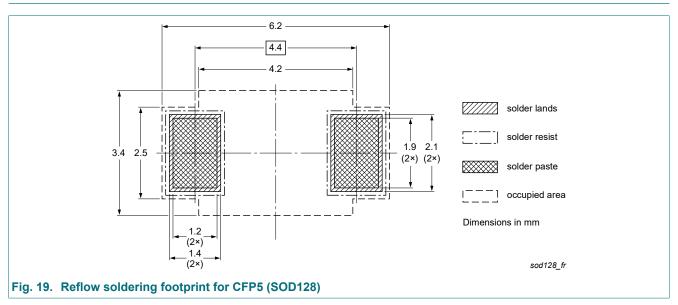
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

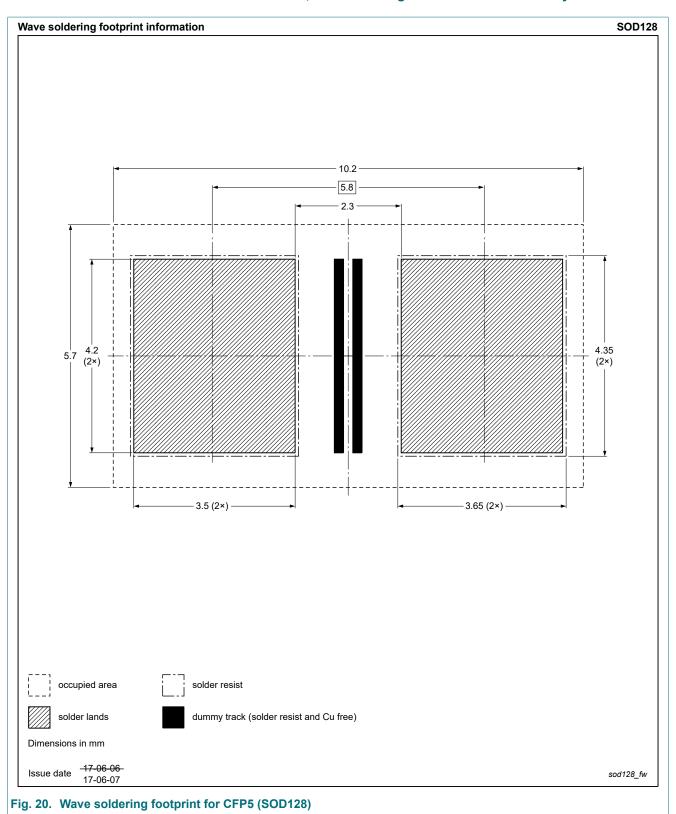
with I_{RMS} defined as RMS current.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

Table of Reviews							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG100T50ELP v.2	20240719	Product data sheet	-	PMEG100T50ELP v.1			
Modifications:	Characteristics:I _{RM} and Q _{rr} conditions changed						
PMEG100T50ELP v.1	20210707	Product data sheet	-	-			

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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